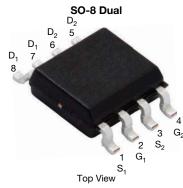
SQ4532AEY



Vishay Siliconix

Automotive N-and P-Channel 30 V (D-S) 175 °C MOSFET



FEATURES

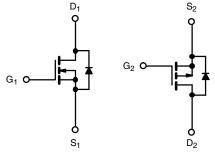
- TrenchFET® power MOSFET
- AEC-Q101 qualified ^c
- 100 % R_q and UIS tested
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>



COMPLIANT HALOGEN

Marking Code: Q4532A

PRODUCT SUMMARY						
	N-CHANNEL	P-CHANNEL				
V _{DS} (V)	30	-30				
$R_{DS(on)} (\Omega)$ at $V_{GS} = \pm 10 \text{ V}$	0.031	0.070				
$R_{DS(on)}$ (Ω) at $V_{GS} = \pm 4.5 \text{ V}$	0.042	0.190				
I _D (A)	7.3	-5.3				
Configuration	N- and p-pair					



N-Channel MOSFET

P-Channel MOSFET

ORDERING INFORMATION	
Package	SO-8
Lead (Pb)-free and halogen-free	SQ4532AEY (for detailed order number please see <u>www.vishay.com/doc?79771</u>)

ABSOLUTE MAXIMUM RATINGS (T _C = 25 °C, unless otherwise noted)							
PARAMETER		SYMBOL	N-CHANNEL	P-CHANNEL	UNIT		
Drain-source voltage		V _{DS}	30	-30	v		
Gate-source voltage		V _{GS}	± 20		v		
Continuous drain current	T _C = 25 °C	1	7.3	-5.3			
	T _C = 125 °C	. I _D	4.2	-3			
Continuous source current (diode conduction)	I _S	4.2	-3	А			
Pulsed drain current ^a		I _{DM}	29	-21			
Single pulse avalanche current	L = 0.1 mH	I _{AS}	10	-9			
Single pulse avalanche energy		E _{AS}	5	4	mJ		
Maximum power dissipation ^a	T _C = 25 °C	Р	3.3	3.3	w		
Maximum power dissipation "	T _C = 125 °C	P _D	1.1	1.1	VV		
Operating junction and storage temperature rang	le	T _J , T _{stg}	-55 to	o +175	°C		

THERMAL RESISTANCE RATINGS								
PARAMETER		SYMBOL	N-CHANNEL	P-CHANNEL	UNIT			
Junction-to-ambient	PCB mount ^b	R _{thJA}	110	105	°C/W			
Junction-to-foot (drain)		R _{thJF}	45	45	0/10			

Notes

a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %

b. When mounted on 1" square PCB (FR4 material)

c. Parametric verification ongoing

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SQ4532AEY

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SPECIFICATIONS (T _C = 25	1		•			TVD			
PARAMETER	SYMBOL		TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT	
Static	1	N/	0 1 0504	NL Ch	20				
Drain-source breakdown voltage	V _{DS}	V _{GS} = 0, I _D = 250 μA V _{GS} = 0, I _D = -250 μA		N-Ch	30	-	-		
				P-Ch	-30	-	-	v	
Gate-source threshold voltage	V _{GS(th)}		V_{GS} , $I_D = 250 \mu A$	N-Ch	1.5	2	2.5		
		V _{DS} =	V_{GS} , I_D = -250 μ A	P-Ch	-1.5	-2	-2.5		
Gate-source leakage	I _{GSS}	V _{DS} =	0 V, $V_{GS} = \pm 20 V$	N-Ch	-	-	± 100	nA	
		<u>)</u>	N/ 00.1/	P-Ch	-	-	± 100		
		$V_{GS} = 0 V$	V _{DS} = 30 V	N-Ch	-	-	1	-	
		$V_{GS} = 0 V$	$V_{DS} = -30 V$	P-Ch	-	-	-1		
Zero gate voltage drain current	I _{DSS}	$V_{GS} = 0 V$	V _{DS} = 30 V, T _J = 125 °C	N-Ch	-	-	50	μA	
0	200	$V_{GS} = 0 V$	V _{DS} = -30 V, T _J = 125 °C	P-Ch	-	-	-50		
		$V_{GS} = 0 V$	V _{DS} = 30 V, T _J = 175 °C	N-Ch	-	-	150		
		$V_{GS} = 0 V$	V _{DS} = -30 V, T _J = 175 °C	P-Ch	-	-	-150		
On-state drain current ^a	I _{D(on)}	$V_{GS} = 10 V$	$V_{DS} = 5 V$	N-Ch	15	-	-	- A	
	·D(01)	$V_{GS} = -10 V$	V _{DS} = -5 V	P-Ch	-15	-	A		
		$V_{GS} = 10 V$	I _D = 4.9 A	N-Ch	-	0.021	0.031	Ω	
Drain-source on-state resistance ^a		$V_{GS} = -10 V$	I _D = -3.5 A	P-Ch	-	0.056	0.070		
	R _{DS(on)}	$V_{GS} = 10 V$	$I_D = 4.9 \text{ A}, \text{ T}_J = 125 \ ^\circ\text{C}$	N-Ch	-	-	0.064		
		$V_{GS} = -10 V$	$I_D = -3.5 \text{ A}, \text{ T}_J = 125 \ ^\circ\text{C}$	P-Ch	-	-	0.100		
		$V_{GS} = 10 V$	I _D = 4.9 A, T _J = 175 °C	N-Ch	-	-	0.082		
		V _{GS} = -10 V	I _D = -3.5 A, T _J = 175 °C	P-Ch	-	-	0.117		
		V _{GS} = 4.5 V	I _D = 4.1 A	N-Ch	-	0.033	0.042		
		$V_{GS} = -4.5 V$	I _D = -2.5 A	P-Ch	-	0.157	0.190		
- h		V _{DS} :	= 15 V, I _D = 4.9 A	N-Ch	-	22	-		
Forward transconductance ^b	9fs	V _{DS} =	-15 V, I _D = -3.5 A	P-Ch	-	5.5	-	S	
Dynamic ^b					I	•	1		
		$V_{GS} = 0 V$	V _{DS} = 15 V, f = 1 MHz	N-Ch	-	357	535		
Input capacitance	C _{iss}	V _{GS} = 0 V	V _{DS} = -15 V, f = 1 MHz	P-Ch	-	352	528		
	-	$V_{GS} = 0 V$	V _{DS} = 15 V, f = 1 MHz	N-Ch	-	82	123		
Output capacitance	C _{oss}	V _{GS} = 0 V	V _{DS} = -15 V, f = 1 MHz	P-Ch	-	95	142	pF	
		$V_{GS} = 0 V$	V _{DS} = 15 V, f = 1 MHz	N-Ch	-	36	53		
Reverse transfer capacitance	Circo	$V_{GS} = 0 V$	V _{DS} = -15 V, f = 1 MHz	P-Ch	-	59	88		
		V _{GS} = 10 V	$V_{DS} = 15 \text{ V}, \text{ I}_{D} = 3.9 \text{ A}$	N-Ch	-	5.9	7.8		
Total gate charge	Qg	V _{GS} = -10 V	$V_{DS} = -15 \text{ V}, \text{ I}_{D} = -2.5 \text{ A}$	P-Ch	-	7.9	10.2		
	Q _{gs}	$V_{GS} = 10 V$ $V_{GS} = 10 V$	$V_{DS} = 15 \text{ V}, \text{ I}_{D} = 3.9 \text{ A}$	N-Ch	-	1	-	n	
Gate-source charge		$V_{GS} = -10 V$ $V_{GS} = -10 V$	$V_{DS} = -15 \text{ V}, \text{ I}_{D} = -2.5 \text{ A}$	P-Ch	-	1.1	-	nC	
		$V_{GS} = 10 V$ $V_{GS} = 10 V$	$V_{DS} = 15 \text{ V}, \text{ I}_{D} = 2.3 \text{ A}$ $V_{DS} = 15 \text{ V}, \text{ I}_{D} = 3.9 \text{ A}$	N-Ch	-	1.9	-	1	
Gate-drain charge ^c	Q _{gd}							-	
		V _{GS} = -10 V	$V_{DS} = -15 \text{ V}, \text{ I}_{D} = -2.5 \text{ A}$	P-Ch N-Ch	-	2.7	-		
Gate resistance	Rg		f = 1 MHz		1.7	3.4	5.1	Ω	
	Ŭ			P-Ch	2.8	5.8 8.6			



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SPECIFICATIONS ($T_C = 25 \text{ °C}$, unless otherwise noted)								
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT		
T		$\label{eq:VDD} \begin{array}{l} V_{DD} = 15 \; V, R_L = 15 \; \Omega \\ I_D \cong 1 \; A, V_GEN = 10 \; V, R_g = 1 \; \Omega \end{array}$	N-Ch	-	7	10		
Turn-on delay time	t _{d(on)}	$\label{eq:VDD} \begin{array}{l} V_{DD} = -15 \ V, \ R_L = 15 \ \Omega \\ I_D \cong -1 \ A, \ V_{GEN} = -10 \ V, \ R_g = 1 \ \Omega \end{array}$	P-Ch	-	6	9		
Rise time	t _r	$\begin{array}{l} V_{DD} = 15 \; V, R_L = 15 \; \Omega \\ I_D \cong 1 \; A, V_GEN = 10 \; V, R_g = 1 \; \Omega \end{array}$	N-Ch	-	17	21		
	۲ŗ	$\begin{array}{l} V_{DD}=-15 \ V, \ R_L=15 \ \Omega \\ I_D\cong-1 \ A, \ V_{GEN}=-10 \ V, \ R_g=1 \ \Omega \end{array}$	P-Ch	-	17	21	ns	
Turn-off delay time	t _{d(off)}	$\label{eq:VDD} \begin{array}{l} V_{DD} = 15 \; V, \; R_L = 15 \; \Omega \\ I_D \cong 1 \; A, \; V_GEN = 10 \; V, \; R_g = 1 \; \Omega \end{array}$	N-Ch	-	10	14	115	
		V_{DD} = -15 V, R_L = 15 Ω I_D \cong -1 A, V_{GEN} = -10 V, R_g = 1 Ω	P-Ch	-	19	24		
Fall time t _f	+.	$\label{eq:V_DD} \begin{array}{l} V_{DD} = 15 \; V, R_L = 15 \; \Omega \\ I_D \cong 1 \; A, V_GEN = 10 \; V, R_g = 1 \; \Omega \end{array}$	N-Ch	-	19	24		
	t _f	$\begin{array}{l} V_{DD}=-15 \ V, \ R_L=15 \ \Omega \\ I_D\cong-1 \ A, \ V_{GEN}=-10 \ V, \ R_g=1 \ \Omega \end{array}$	P-Ch	-	16	20		
Source-Drain Diode Ratings and Characteristics ^b								
Pulsed current ^a	I _{SM}		N-Ch	-	-	29	А	
			P-Ch	-	-	-21	~	
Forward voltage	V _{SD}	I _S = 2 A	N-Ch	-	0.8	1.2	v	
i orward voltage		I _S = -1.5 A	P-Ch	P-Ch0.8 -1		-1.2	v	

Notes

a. Pulse test; pulse width $\leq 300~\mu s,~duty~cycle \leq 2~\%$

b. Guaranteed by design, not subject to production testing

c. Independent of operating temperature

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



= - 55 °C T_C

8

25

30

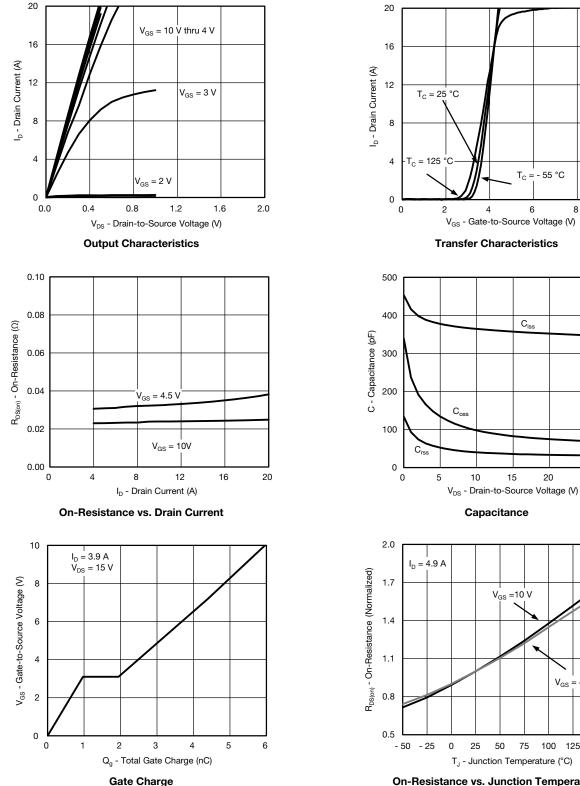
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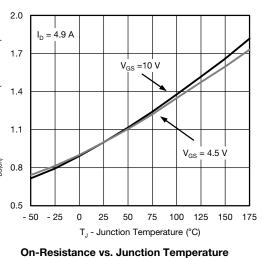
6

C_{iss}

4

N-CHANNEL TYPICAL CHARACTERISTICS ($T_A = 25$ °C, unless otherwise noted)





15

Capacitance

20

10

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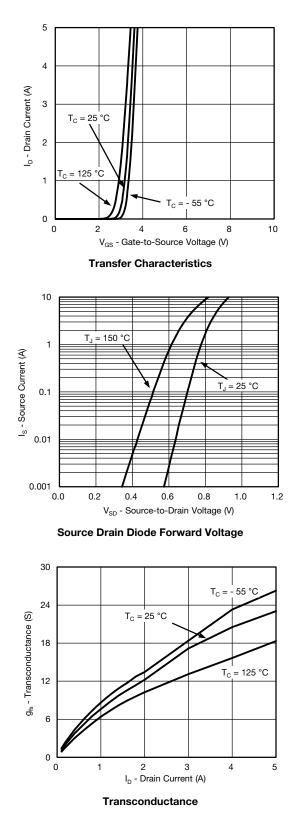
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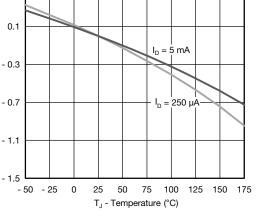
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N-CHANNEL TYPICAL CHARACTERISTICS ($T_A = 25 \text{ °C}$, unless otherwise noted)

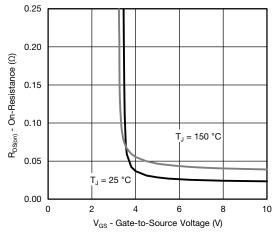




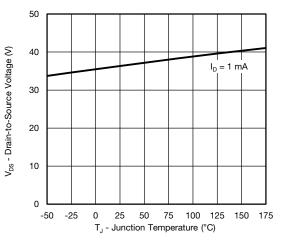
Threshold Voltage

0.5

V_{GS(th)} Variance (V)



On-Resistance vs. Gate-to-Source Voltage



Drain Source Breakdown vs. Junction Temperature

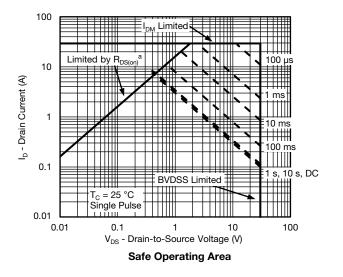
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N-CHANNEL THERMAL RATINGS (T_A = 25 °C, unless otherwise noted)



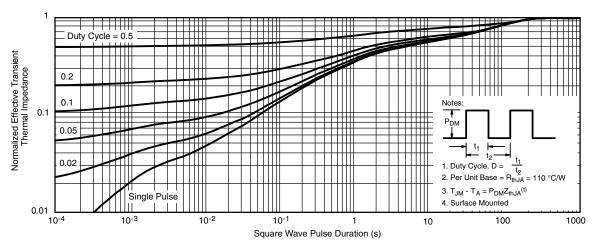
Note

a. V_{GS} > minimum V_{GS} at which $R_{DS(\text{on})}$ is specified

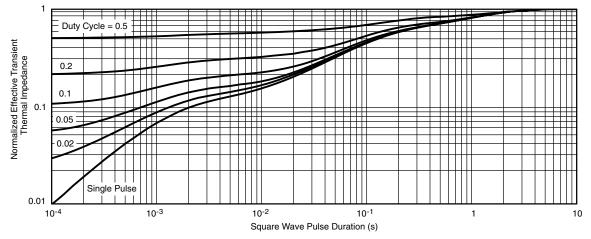




N-CHANNEL THERMAL RATINGS (T_A = 25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Foot

Note

• The characteristics shown in the two graphs

- Normalized Transient Thermal Impedance Junction-to-Ambient (25 °C)

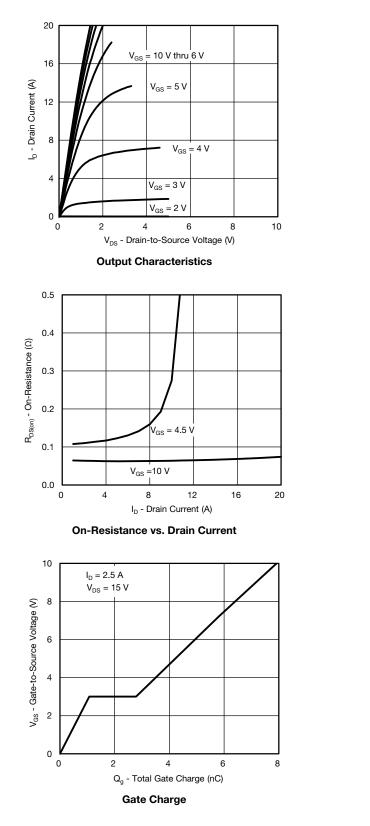
- Normalized Transient Thermal Impedance Junction-to-Case (25 °C)

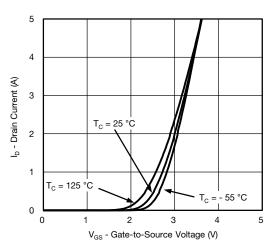
are given for general guidelines only to enable the user to get a "ball park" indication of part capabilities. The data are extracted from single pulse transient thermal impedance characteristics which are developed from empirical measurements. The latter is valid for the part mounted on printed circuit board - FR4, size 1" x 1" x 0.062", double sided with 2 oz. copper, 100 % on both sides. The part capabilities can widely vary depending on actual application parameters and operating conditions.

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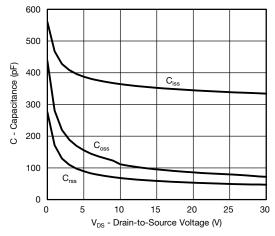


P-CHANNEL TYPICAL CHARACTERISTICS ($T_A = 25 \text{ °C}$, unless otherwise noted)

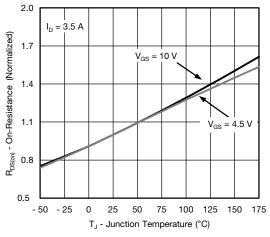




Transfer Characteristics



Capacitance



On-Resistance vs. Junction Temperature

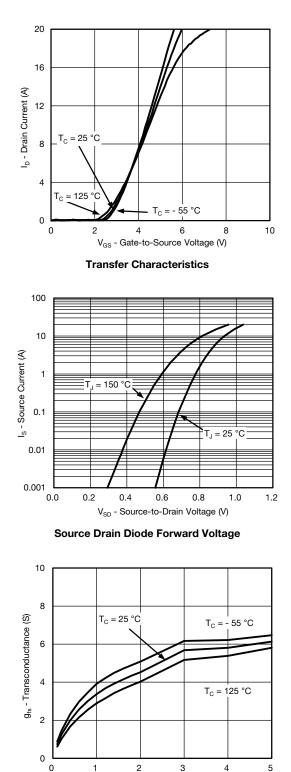
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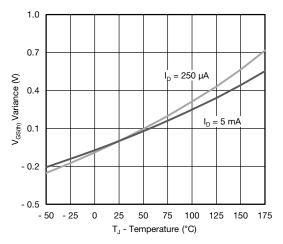


P-CHANNEL TYPICAL CHARACTERISTICS ($T_A = 25 \text{ °C}$, unless otherwise noted)

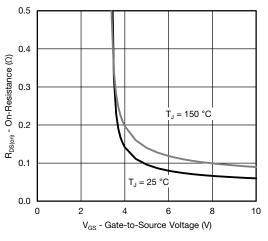




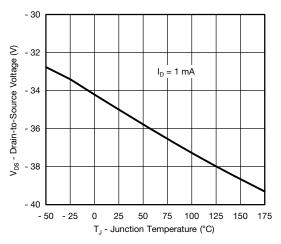
Transconductance



Threshold Voltage





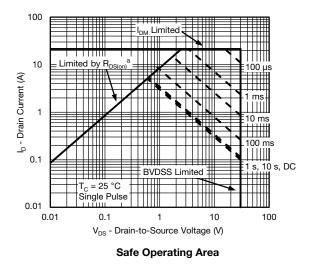


Drain Source Breakdown vs. Junction Temperature

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P-CHANNEL THERMAL RATINGS (T_A = 25 °C, unless otherwise noted)



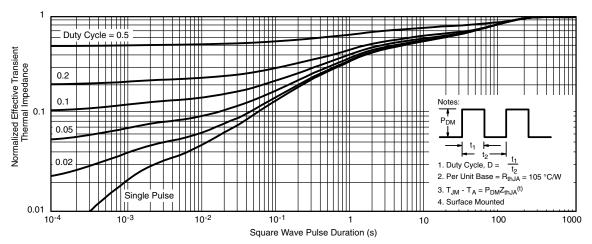
Note

a. V_{GS} > minimum V_{GS} at which $R_{DS(on)}$ is specified

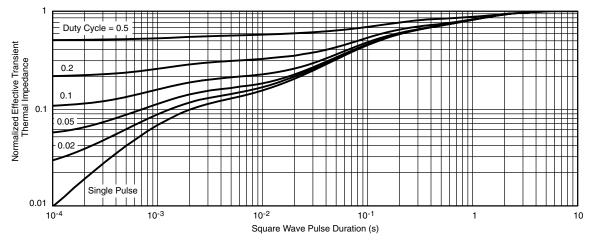




P-CHANNEL THERMAL RATINGS ($T_A = 25 \text{ °C}$, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Foot

Note

- The characteristics shown in the two graphs
 - Normalized Transient Thermal Impedance Junction-to-Ambient (25 °C)
 - Normalized Transient Thermal Impedance Junction-to-Case (25 °C)

are given for general guidelines only to enable the user to get a "ball park" indication of part capabilities. The data are extracted from single pulse transient thermal impedance characteristics which are developed from empirical measurements. The latter is valid for the part mounted on printed circuit board - FR4, size 1" x 1" x 0.062", double sided with 2 oz. copper, 100 % on both sides. The part capabilities can widely vary depending on actual application parameters and operating conditions.

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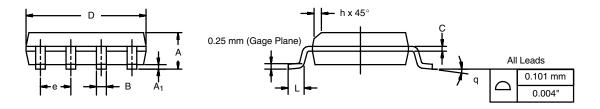


Package Information

Vishay Siliconix

SOIC (NARROW): 8-LEAD JEDEC Part Number: MS-012





	MILLIM	IETERS	INC	HES		
DIM	Min	Мах	Min	Max		
A	1.35	1.75	0.053	0.069		
A ₁	0.10	0.20	0.004	0.008		
В	0.35	0.51	0.014	0.020		
С	0.19	0.25	0.0075	0.010		
D	4.80	5.00	0.189	0.196		
E	3.80	4.00	0.150	0.157		
е	1.27	BSC	0.050 BSC			
н	5.80	6.20	0.228	0.244		
h	0.25	0.50	0.010	0.020		
L	0.50	0.93	0.020	0.037		
q	0°	8°	0°	8°		
S	0.44	0.64	0.018	0.026		
ECN: C-06527-Rev. I, 11-Sep-06 DWG: 5498						

Application Note 826

Vishay Siliconix



RECOMMENDED MINIMUM PADS FOR SO-8



Recommended Minimum Pads Dimensions in Inches/(mm)

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